



# TECHNICAL SPECIFICATION



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## Nanomanufacturing – Key control characteristics – Part 6-8: Graphene – Sheet resistance: In-line four-point probe

INTERNATIONAL  
ELECTROTECHNICAL  
COMMISSION

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

**NANOMANUFACTURING –  
KEY CONTROL CHARACTERISTICS –**

**Part 6-8: Graphene – Sheet resistance: In-line four-point probe**

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The text of this Technical Specification is based on the following documents:

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Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this Technical Specification is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/publications](http://www.iec.ch/publications).

A list of all parts of the IEC TS 62607 series, published under the general title *Nanomanufacturing – Key control characteristics*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under [webstore.iec.ch](http://webstore.iec.ch) in the data related to the specific document. At this date, the document will be

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## INTRODUCTION

Graphene is a single layer of carbon atoms arranged in a honeycomb lattice. Graphene has shown many outstanding properties, among which is a high electrical conductivity. Nowadays graphene can be easily grown and transferred on large area (cm<sup>2</sup> to even m<sup>2</sup>) and even roll-to-roll supports using chemical vapour deposition (CVD) techniques. This is already enabling its commercial applications in electrotechnical products.

Electrical conductivity of graphene samples can depend on many factors: structural quality, contamination, coupling with the physical support used for a given application to name a few. On practical grounds, the sheet resistance,  $R_S$ , is a quantity which can be used as global measure of the local conductivity of a sample with finite geometrical dimensions. In order to check the reproducibility of the electrical properties of graphene, the sheet resistance is clearly a key control characteristic for this material.

The in-line four-point probe method (4PP) allows the measurement of the sheet resistance of samples of arbitrary shape, with isotropic conductivity and uniform carrier density by performing four-terminal resistance measurements with electrical contact provided by a commercially available dedicated tool. The method is fast (it takes a few minutes) and easy to implement, since many commercial fixtures are available.

The four-terminal resistance measurements approach allows to minimize the effect of the contact resistance that appears between graphene and the measurement probes.

The 4PP method provides a certain degree of spatial resolution in principle, depending on the sampling plan adopted to map the sample area.

In this document it is explained how to specifically apply the 4PP method on chemical vapour deposited graphene on rigid insulating support and perform a reliable estimation of the sample KCC sheet resistance,  $R_S$ , also considering the non-ideal nature of commercial graphene.

## NANOMANUFACTURING – KEY CONTROL CHARACTERISTICS –

### Part 6-8: Graphene – Sheet resistance: In-line four-point probe

#### 1 Scope

This part of IEC TS 62607 establishes a method to determine the key control characteristic

- sheet resistance  $R_S$  [measured in ohm per square ( $\Omega/\text{sq}$ )],

by the

- in-line four-point probe method, 4PP.

The sheet resistance  $R_S$  is derived by measurements of four-terminal electrical resistance performed on four electrodes placed on the surface of the planar sample.

- The measurement range for  $R_S$  of the graphene samples with the method described in this document goes from  $10^{-2} \Omega/\text{sq}$  to  $10^4 \Omega/\text{sq}$ .
- The method is applicable for CVD graphene provided it is transferred to quartz substrates or other insulating materials (quartz,  $\text{SiO}_2$  on Si, as well as graphene grown from silicon carbide).
- The method is complementary to the van der Pauw method (IEC 62607-6-7) for what concerns the measurement of the sheet resistance and can be useful when it is not possible to reliably place contacts on the sample boundary.

#### 2 Normative references

There are no normative references in this document.